# MA2SP060G

## Silicon planar type

#### For high frequency switch

#### ■ Features

• Low terminal capacitance:  $C_t \le 0.6 \text{ pF}$ • Low forward dynamic resistance:  $r_f \le 1.2 \Omega$ 

### ■ Absolute Maximum Ratings $T_a = 25$ °C

Parameter	Symbol	Rating	Unit
Reverse voltage	$V_R$	60	V
Forward current	$I_F$	100	mA
Junction temperature	Tj	150	°C
Storage temperature	$T_{stg}$	-55 to +150	°C

#### Package

Code

SSMini2-F4

Pin Name

1: Anode

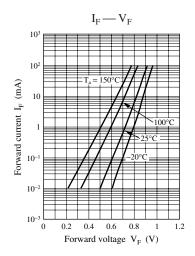
2: Cathode

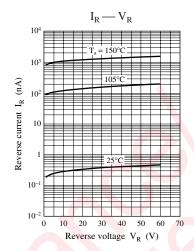
■ Marking Symbol: 6P

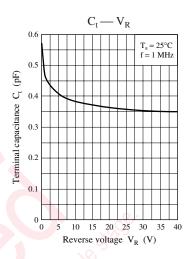
### ■ Electrical Characteristics T<sub>a</sub> = 25°C ± 3°C

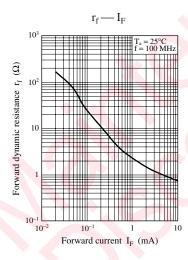
Parameter	Symbol	Conditions	Min	Тур	Max	Unit
Forward voltage	$V_{\rm F}$	$I_F = 10 \text{ mA}$	37 . 1	0.85	1.0	V
Reverse current	I <sub>R</sub>	$V_R = 60 \text{ V}$	01/1	1.0	100	nA
Terminal capacitance	Ct	$V_R = 1 \text{ V, } f = 1 \text{ MHz}$	90	0.45	0.6	pF
Forward dynamic resistance	$r_{\rm f}$	$I_F = 10 \text{ mA}, f = 100 \text{ MHz}$	20/1	0.80	1.2	Ω

Note) Measuring methods are based on JAPANESE INDUSTRIAL STANDARD JIS C 7031 measuring methods for diodes.



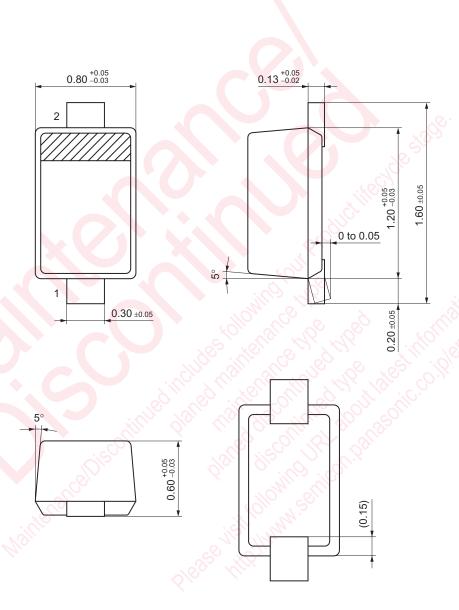






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SSMini2-F4 Unit: mm



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